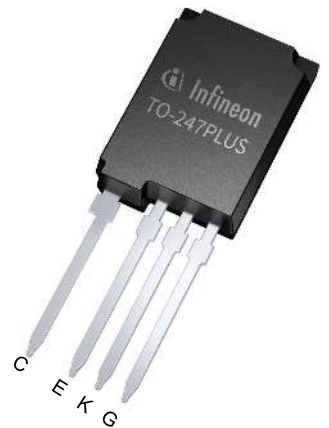


Low switching losses IGBT in Highspeed3 technology co-packed with soft, fast recovery full current rated antiparallel emitter controlled diode

Features

- $V_{CE} = 1200\text{ V}$
- $I_C = 40\text{ A}$
- Ultra-low loss switching losses due to Kelvin emitter pin package in combination with Highspeed3 technology
- High efficiency in hard switching and resonant topologies
- 10 μsec short circuit withstand time at $T_{vj} = 175^\circ\text{C}$
- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low EMI
- Low gate charge Q_G
- Very soft, fast recovery full current antiparallel diode
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>



- Halogen-free
- Lead-free
- Green
- RoHS

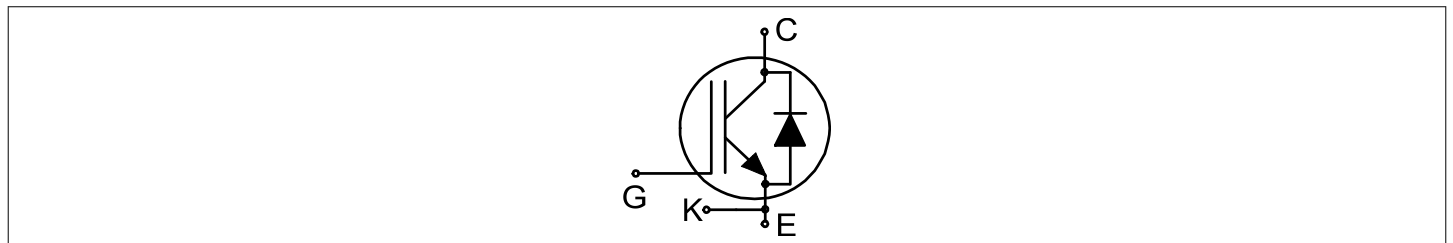
Potential applications

- Industrial UPS
- Charger
- Energy storage
- Three-level solar string inverter

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description



Type	Package	Marking
IKY40N120CH3	PG-TO247-4-2	K40MCH3

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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.3	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				0.5	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$	1200	V	
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25\text{ °C}$	80	A
			$T_c = 134\text{ °C}$	40	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}		160	A	
Turn-off safe operating area		$V_{CE} \leq 1200\text{ V}$, $t_p = 1\text{ }\mu\text{s}$, $T_{vj} \leq 175\text{ °C}$	160	A	
Gate-emitter voltage	V_{GE}		± 20	V	
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}$, $D < 0.01$	± 30	V	
Short-circuit withstand time	t_{SC}	$V_{CC} \leq 600\text{ V}$, $V_{GE} = 15\text{ V}$, Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$, $T_{vj} = 175\text{ °C}$	10	μs	
Power dissipation	P_{tot}	$T_c = 25\text{ °C}$	500	W	
		$T_c = 134\text{ °C}$	136		

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	V_{BRCES}	$I_C = 0.5\text{ mA}$, $V_{GE} = 0\text{ V}$	1200			V

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 40\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		2	2.35	V
			$T_{vj} = 175\text{ °C}$		2.5		
Gate-emitter threshold voltage	V_{GEth}	$I_C = 1.5\text{ mA}, V_{CE} = V_{GE}$		5.1	5.8	6.5	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			250	μA
			$T_{vj} = 175\text{ °C}$		3000		
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$				100	nA
Transconductance	g_{fs}	$I_C = 40\text{ A}, V_{CE} = 20\text{ V}$			14		S
Input capacitance	C_{ies}	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			2385		pF
Output capacitance	C_{oes}	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			235		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			132		pF
Gate charge	Q_G	$I_C = 40\text{ A}, V_{GE} = 15\text{ V}, V_{CC} = 960\text{ V}$			190		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		30		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		29		
Rise time (inductive load)	t_r	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		29		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		32		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		280		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		375		
Fall time (inductive load)	t_f	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		26		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		64		
Turn-on energy	E_{on}	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		2.2		mJ
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		3.1		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Turn-off energy	E_{off}	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 12\ \Omega,$ $R_{G(off)} = 12\ \Omega, L_{\sigma} = 70\text{ nH},$ $C_{\sigma} = 67\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 40\text{ A}$		1.3		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 40\text{ A}$		2.5		
Total switching energy	E_{ts}	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 12\ \Omega,$ $R_{G(off)} = 12\ \Omega, L_{\sigma} = 70\text{ nH},$ $C_{\sigma} = 67\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 40\text{ A}$		3.5		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 40\text{ A}$		5.6		
Operating junction temperature	T_{vj}		-40		175	$^{\circ}\text{C}$	

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	1200	V	
Diode forward current, limited by T_{vjmax}	I_F		$T_C = 25\text{ }^{\circ}\text{C}$	80	A
			$T_C = 100\text{ }^{\circ}\text{C}$	40	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		160	A	

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode forward voltage	V_F	$I_F = 40\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$		1.9	2.3	V
			$T_{vj} = 175\text{ }^{\circ}\text{C}$		1.85		
Diode reverse recovery time	t_{rr}	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		350		ns
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		550		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	Q_{rr}	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		3		μC
					7.5		
Diode peak reverse recovery current	I_{rrm}	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		22		A
					30		
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		188		$\text{A}/\mu\text{s}$
					142		
Operating junction temperature	T_{vj}			-40		175	$^{\circ}\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Electrical Characteristic at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified.

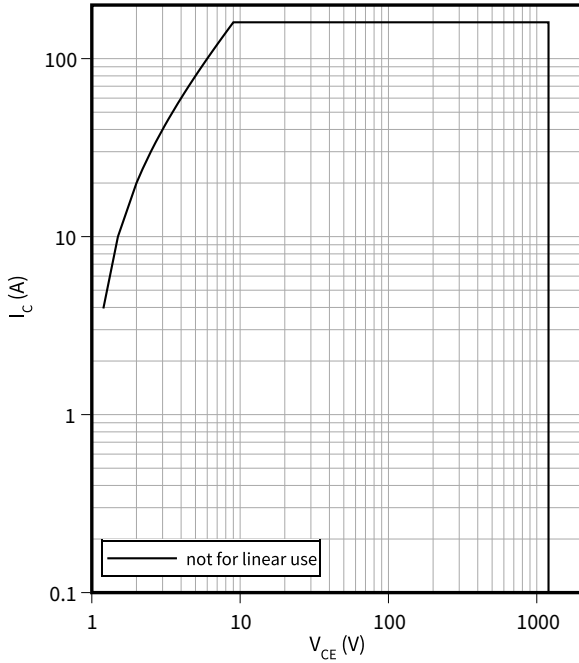
Dynamic test circuit, parasitic inductance L_{σ} , parasitic capacitor C_{σ} from Fig. E. Energy losses include “tail” and diode reverse recovery.

4 Characteristics diagrams

Forward bias safe operating area

$$I_C = f(V_{CE})$$

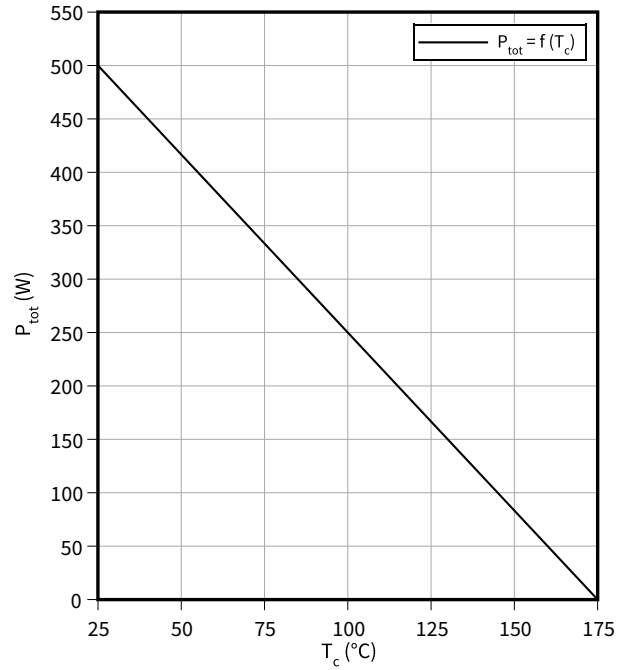
$$D = 0, T_{vj} \leq 175\text{ °C}, V_{GE} = 15\text{ V}, T_c = 25\text{ °C}$$



Power dissipation as a function of case temperature

$$P_{tot} = f(T_c)$$

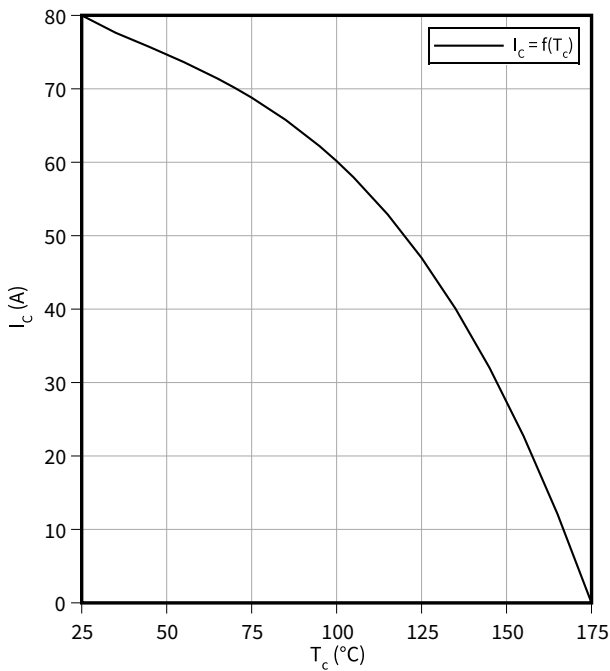
$$T_{vj} \leq 175\text{ °C}$$



Collector current as a function of case temperature

$$I_C = f(T_c)$$

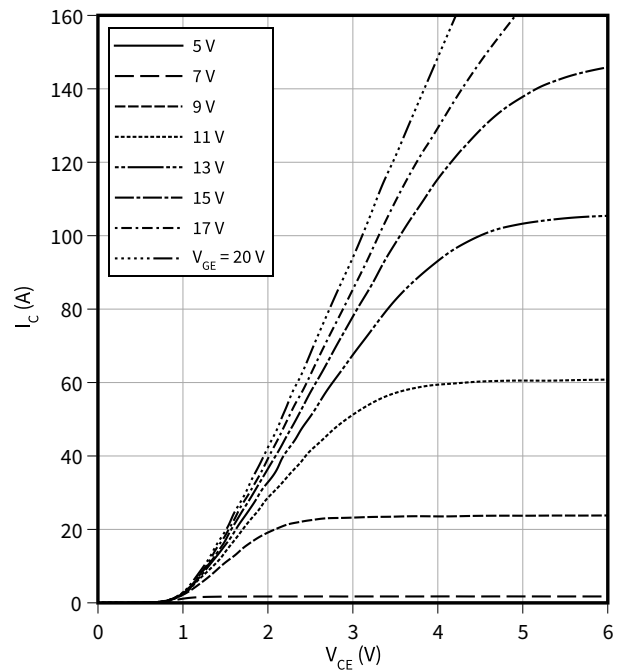
$$T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

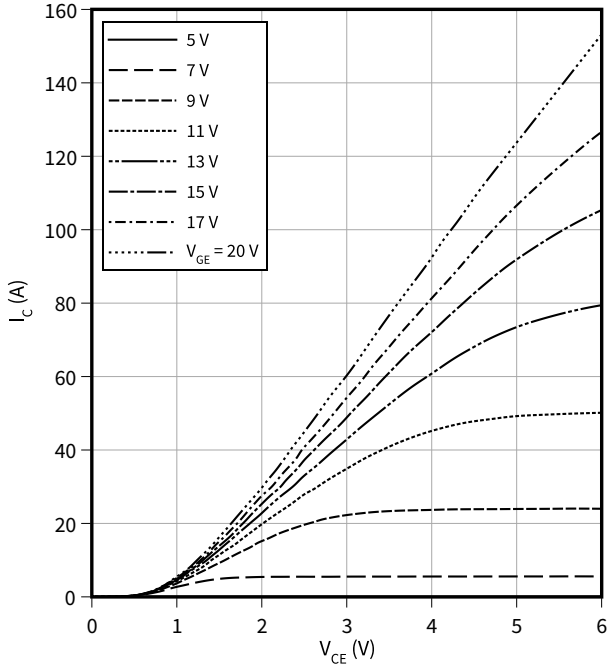
$$T_{vj} = 25\text{ °C}$$



4 Characteristics diagrams

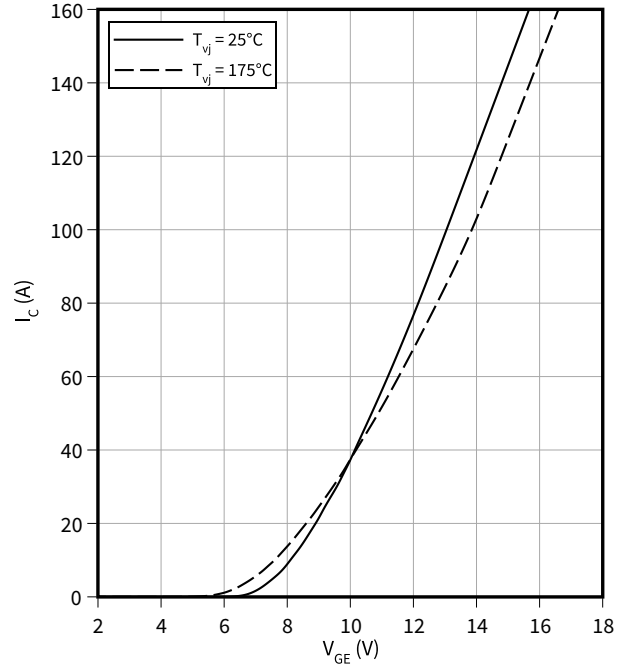
Typical output characteristic

$I_C = f(V_{CE})$
 $T_{vj} = 175\text{ °C}$



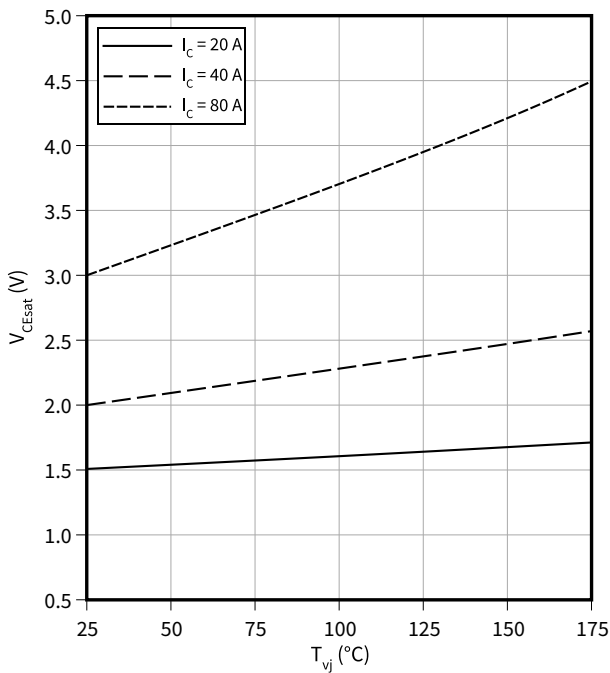
Typical transfer characteristic

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



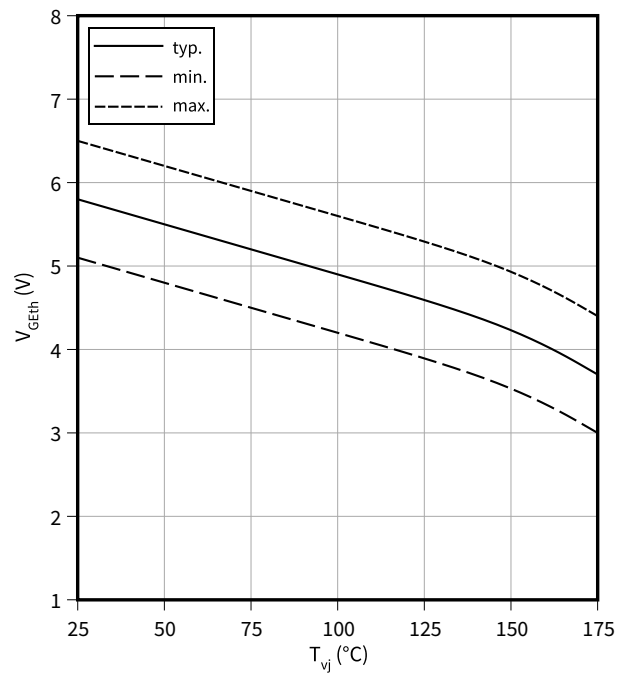
Typical collector-emitter saturation voltage as a function of junction temperature

$V_{CEsat} = f(T_{vj})$
 $V_{GE} = 15\text{ V}$



Gate-emitter threshold voltage as a function of junction temperature

$V_{Geth} = f(T_{vj})$
 $I_C = 1.5\text{ mA}$

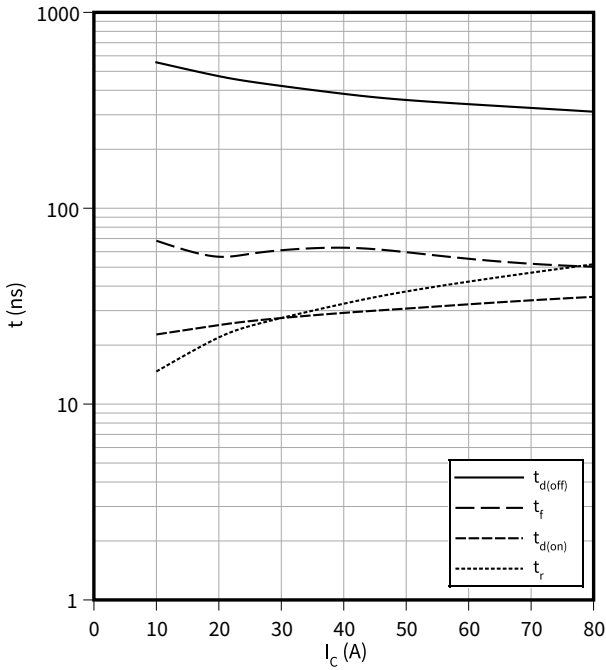


4 Characteristics diagrams

Typical switching times as a function of collector current

$t = f(I_C)$

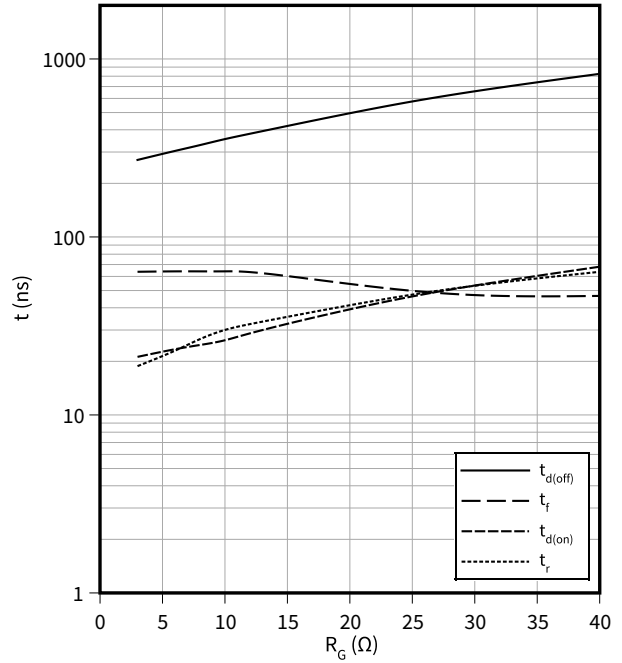
$V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\ \Omega$



Typical switching times as a function of gate resistor

$t = f(R_G)$

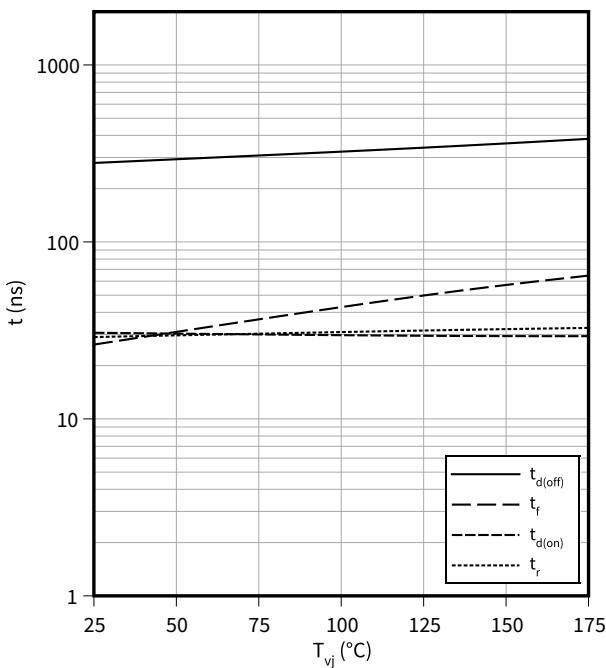
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}$



Typical switching times as a function of junction temperature

$t = f(T_{vj})$

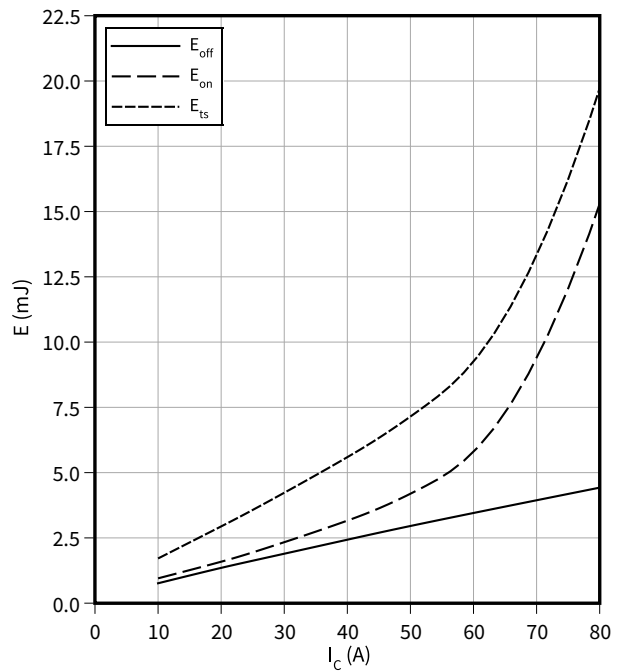
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 12\ \Omega$



Typical switching energy losses as a function of collector current

$E = f(I_C)$

$V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\ \Omega$

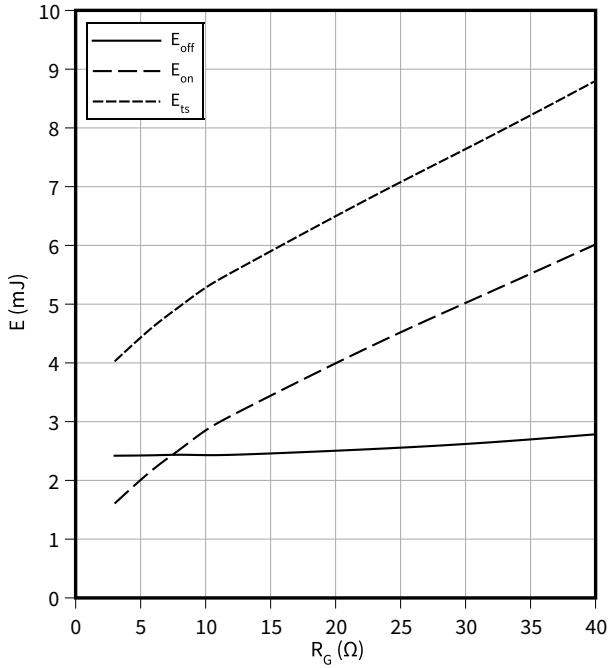


4 Characteristics diagrams

Typical switching energy losses as a function of gate resistor

$E = f(R_G)$

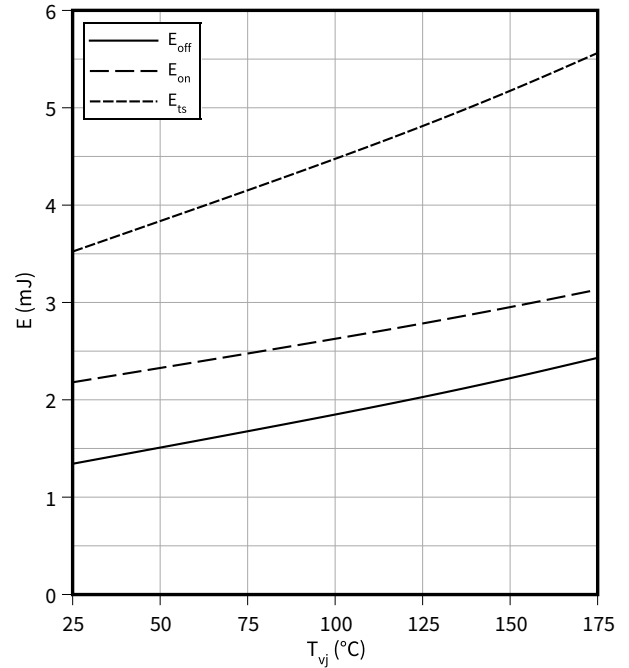
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}$



Typical switching energy losses as a function of junction temperature

$E = f(T_{vj})$

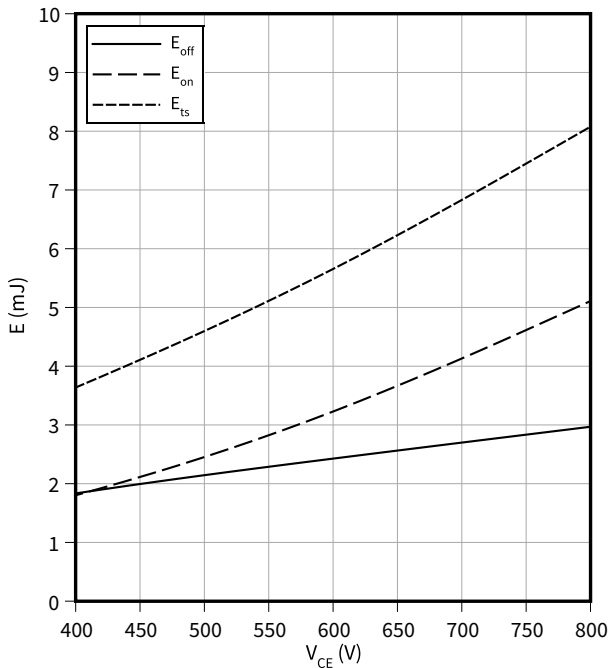
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }\Omega$



Typical switching energy losses as a function of collector emitter voltage

$E = f(V_{CE})$

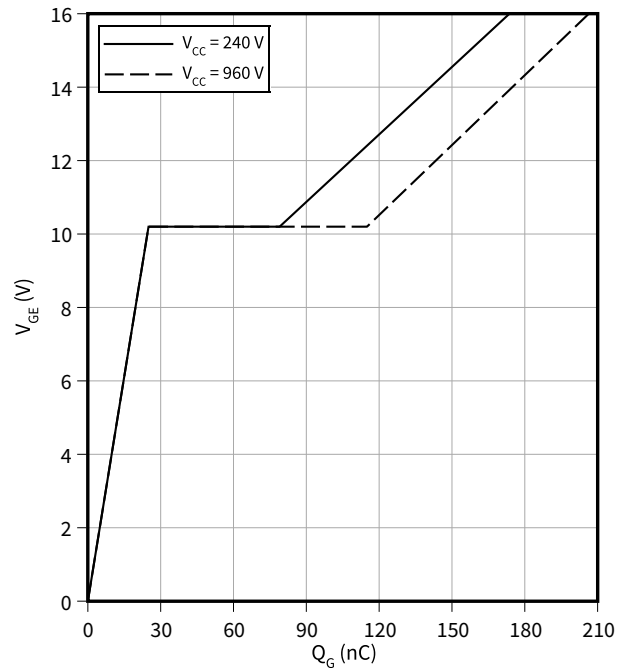
$I_C = 40\text{ A}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }\Omega$



Typical gate charge

$V_{GE} = f(Q_G)$

$I_C = 40\text{ A}$

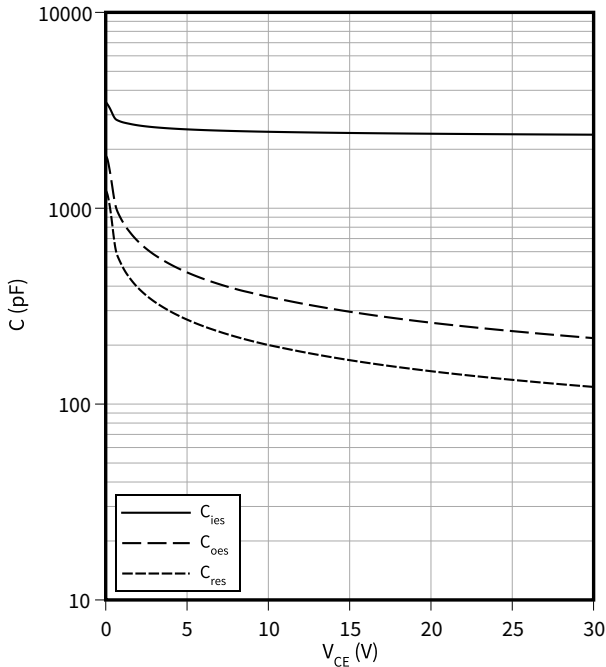


4 Characteristics diagrams

Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$

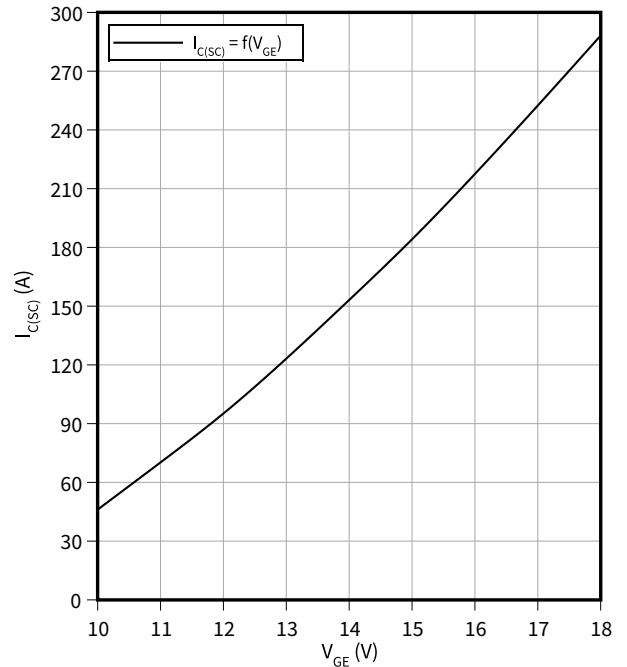
$f = 1000 \text{ kHz}, V_{GE} = 0 \text{ V}$



Typical short circuit collector current as a function of gate-emitter voltage

$I_{C(SC)} = f(V_{GE})$

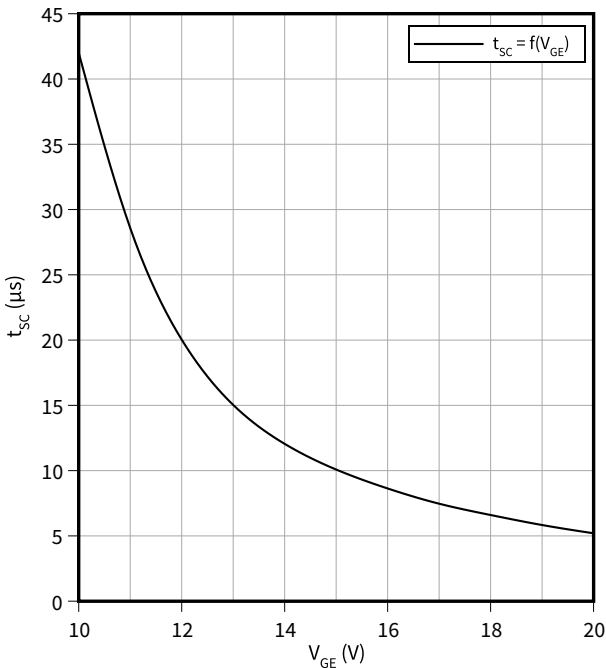
$T_{vj} \leq 175 \text{ }^\circ\text{C}, V_{CC} \leq 600 \text{ V}$



Short circuit withstand time as a function of gate-emitter voltage

$t_{SC} = f(V_{GE})$

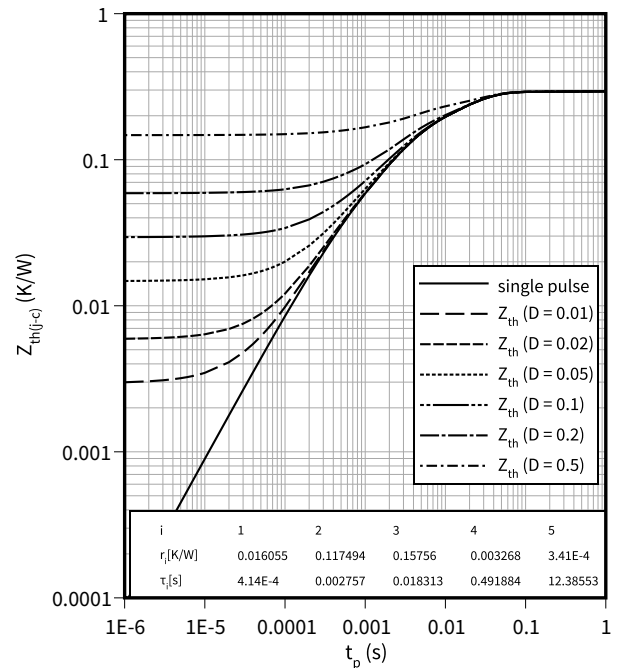
$T_{vj} \leq 175 \text{ }^\circ\text{C}, V_{CC} \leq 600 \text{ V}$



IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$

$D = t_p/T$

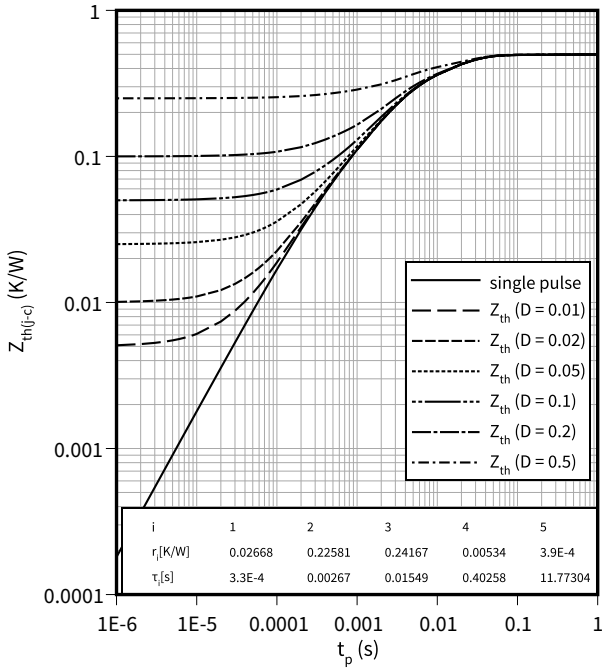


4 Characteristics diagrams

Diode transient thermal impedance as a function of pulse width

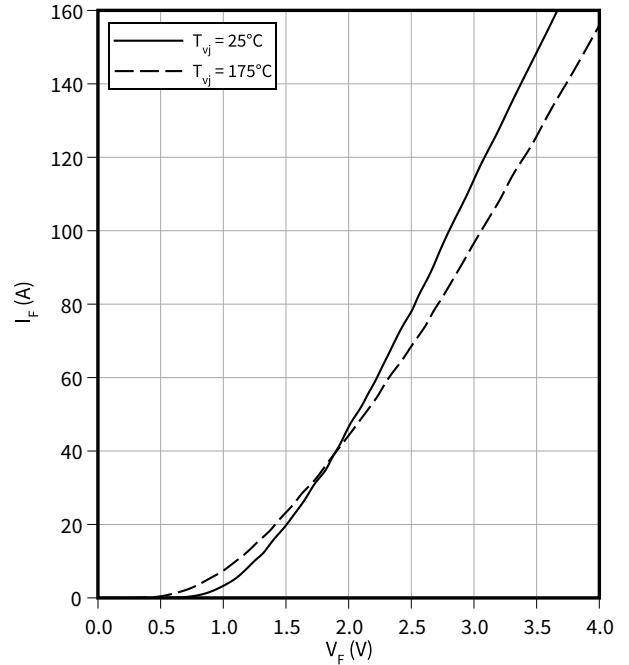
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



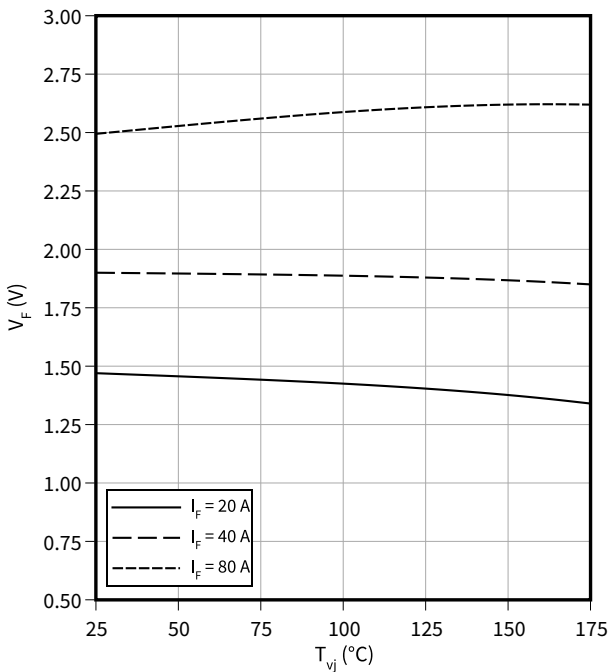
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



Typical diode forward voltage as a function of junction temperature

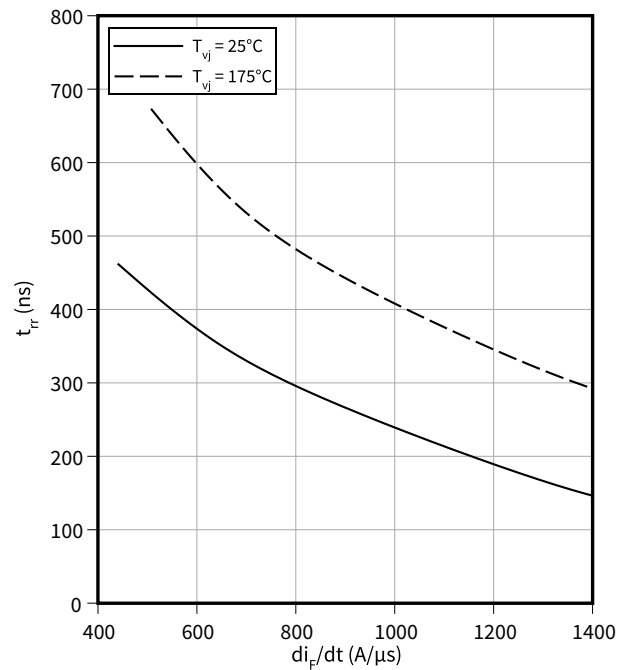
$$V_F = f(T_{vj})$$



Typical reverse recovery time as a function of diode current slope

$$t_{rr} = f(di_F/dt)$$

$$V_R = 600 \text{ V}, I_F = 40 \text{ A}$$

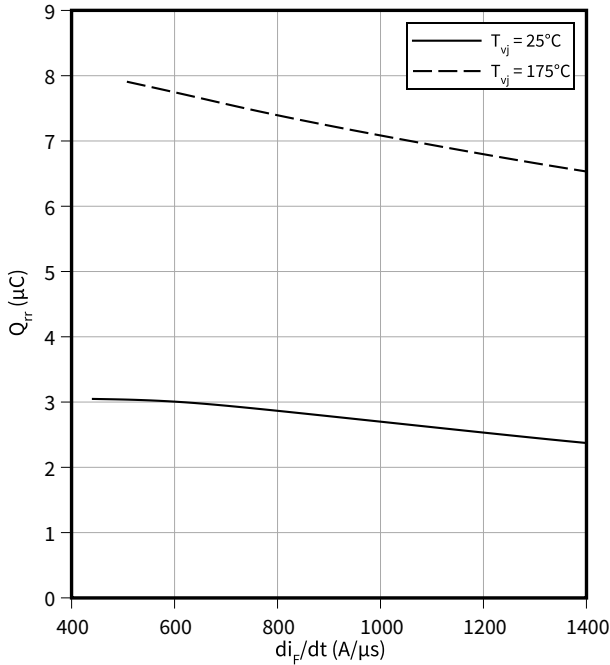


4 Characteristics diagrams

Typical reverse recovery charge as a function of diode current slope

$Q_{rr} = f(di_F/dt)$

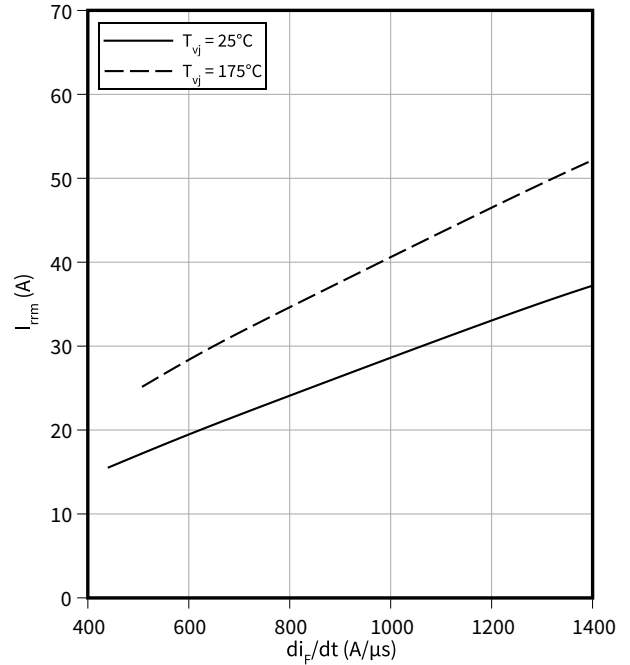
$V_R = 600\text{ V}, I_F = 40\text{ A}$



Typical reverse recovery current as a function of diode current slope

$I_{rrm} = f(di_F/dt)$

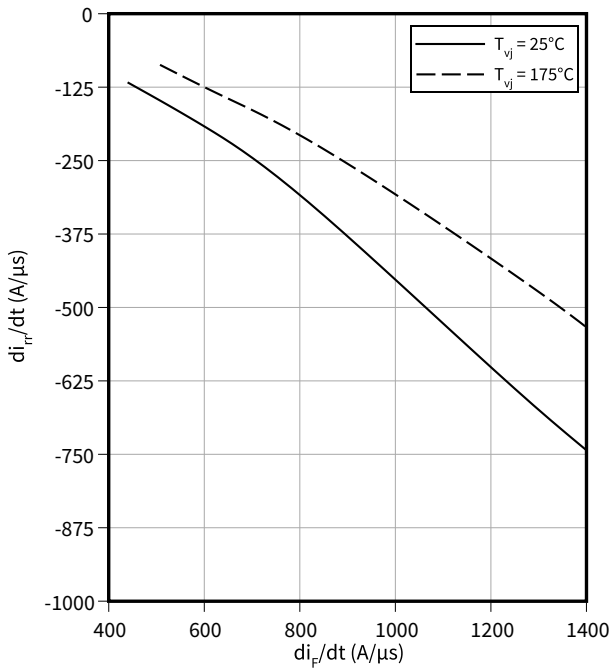
$V_R = 600\text{ V}, I_F = 40\text{ A}$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

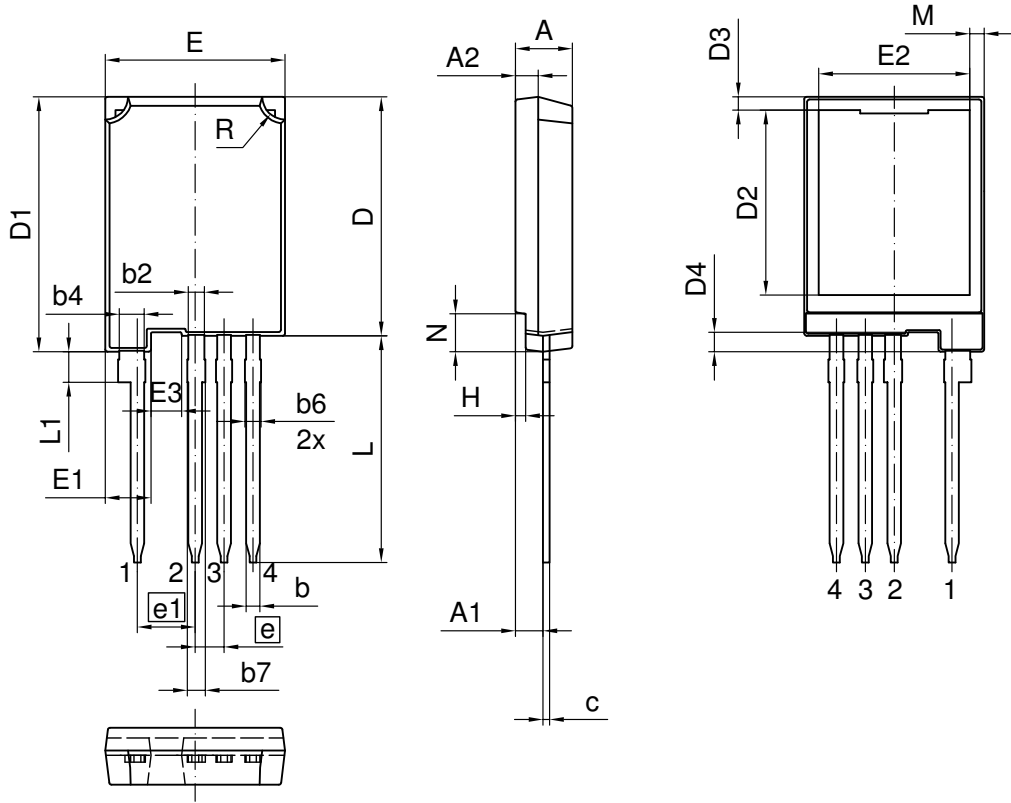
$di_{rr}/dt = f(di_F/dt)$

$V_R = 600\text{ V}, I_F = 40\text{ A}$



5 Package outlines

PG-TO247-4-2



NOTES:

PACKAGE SURFACE ROUTE BETWEEN PIN 1 & PIN 2 WILL BE 5.1mm MIN.

ALL b... AND c DIMENSIONS INCLUDING PLATING EXCEPT AREA OF CUTTING

DIMENSION	MILLIMETERS	
	MIN.	MAX.
A	4.9	5.1
A1	2.31	2.51
A2	1.9	2.1
b	1.16	1.29
b2	1.36	1.49
b4	2.16	2.29
b6	1.16	1.45
b7	1.16	1.65
c	0.59	0.66
D	20.9	21.1
D1	22.3	22.5
D2	15.95	16.55
D3	1	1.35
D4	1.6	1.8
E	15.7	15.9
E1	3.9	4.1
E2	13.1	13.5
E3	2.58	2.78
e	2.54	
e1	5.08	
H	0.8	1
L	19.8	20.1
L1	2.55	2.85
M	0.97	1.57
N	3.24	3.44
R	1.9	2.1

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EUROPEAN PROJECTION
ISSUE DATE 23.09.2016

Figure 1

6 Testing conditions

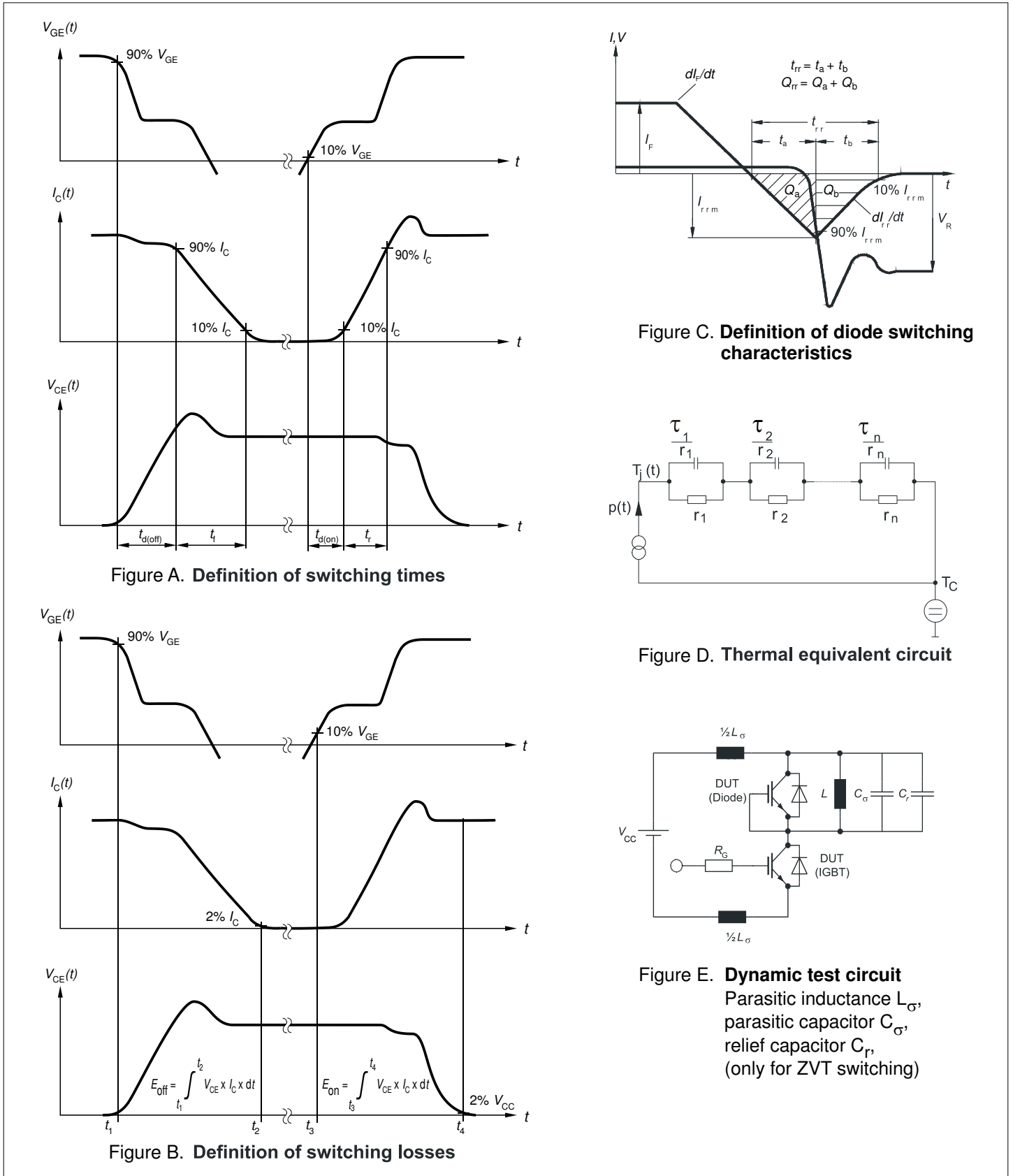


Figure 2

Revision history

Document revision	Date of release	Description of changes
V2.1	2017-04-26	Final data sheet
V2.2	2017-06-09	Update Figure 26
V2.3	2019-04-15	Update condition for V _{geth} page 4 and Fig.11
n/a	2020-11-30	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2023-01-19	Correction of diagram: “Typical switching energy losses as a function of junction temperature”

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